



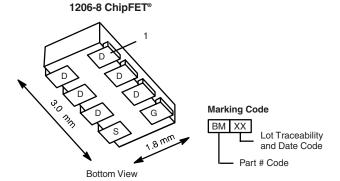
# P-Channel 1.8-V (G-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
	0.033 at V <sub>GS</sub> = - 4.5 V	- 7.1			
- 8	0.043 at V <sub>GS</sub> = - 2.5 V	- 6.2	14		
	0.060 at V <sub>GS</sub> = - 1.8 V	- 5.3			

#### **FEATURES**

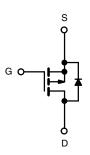
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET<sup>®</sup> Power MOSFET





Ordering Information: Si5445BDC-T1-E3 (Lead (Pb)-free)

Si5445BDC-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	T <sub>A</sub> = 25 °C, unles	ss otherwise r	oted			
Parameter		Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		$V_{DS}$	- 8		V	
Gate-Source Voltage		V <sub>GS</sub>	± 8			
Continuous Drain Current /T 150 °C\8	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	- 7.1	- 5.2	٨	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 85 °C		- 5.2	- 3.7		
Pulsed Drain Current		I <sub>DM</sub>	± 20		Α	
Continuous Source Current <sup>a</sup>		I <sub>S</sub>	- 2.1	- 1.1		
Mariana Barra Birata di ad	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5	1.3	W	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 85 °C		1.3	0.7		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) <sup>b, c</sup>			260		,0	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Mariana la Ambianta	t ≤ 5 s	R <sub>thJA</sub>	45	50	°C/W
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		85	95	
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	17	20	

#### Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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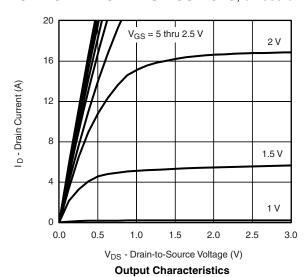
<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C	<b>SPECIFICATIONS</b> $T_J = 25$ °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.45		- 1.0	V		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -8 V, V <sub>GS</sub> = 0 V			- 1			
		$V_{DS} = -8 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			μA			
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 20			Α		
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = -4.5 \text{ V}, I_D = -5.2 \text{ A}$		0.027	0.033	Ω		
	R <sub>DS(on)</sub>	$V_{GS} = -2.5 \text{ V}, I_D = -4.5 \text{ A}$		0.035	0.043			
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 1.7 A		0.050	0.060			
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -5 \text{ V}, I_{D} = -5.2 \text{ A}$		18		S		
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	I <sub>S</sub> = - 1.1 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.2	V		
Dynamic <sup>b</sup>								
Total Gate Charge	$Q_g$			14	21			
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -4 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -5.2 \text{ A}$		1.8		nC		
Gate-Drain Charge	$Q_{gd}$			3.3				
Gate Resistance	$R_g$	f = 1 MHz		8		Ω		
Turn-On Delay Time	t <sub>d(on)</sub>			12	20			
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 4 V, $R_L$ = 4 $\Omega$		22	35			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ - 1 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 6 $\Omega$		75	115	ns		
Fall Time	t <sub>f</sub>			50	75			
Source-Drain Reverse Recovery Time t <sub>rr</sub>		I <sub>E</sub> = - 1.1 A, dl/dt = 100 A/μs		75	115			
Reverse Recovery Charge	Q <sub>rr</sub>	i <sub>F</sub> = - 1.1 A, αί/αι = 100 A/μS		40	60	nC		

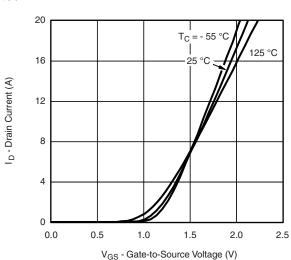
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



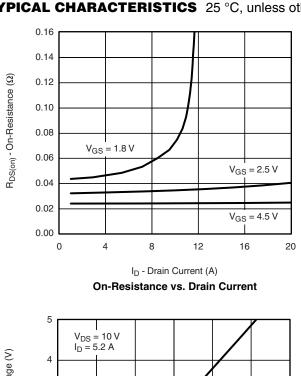


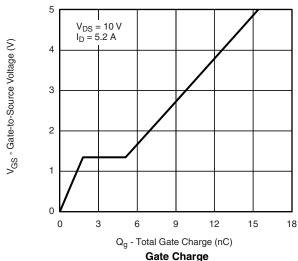


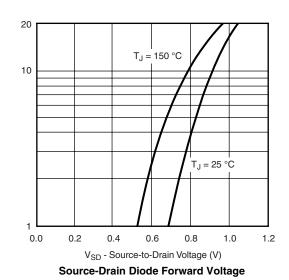


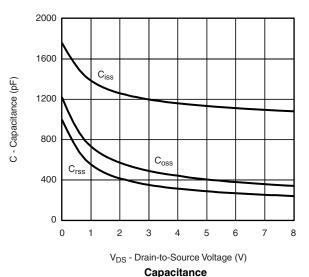


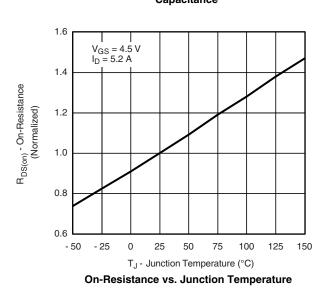
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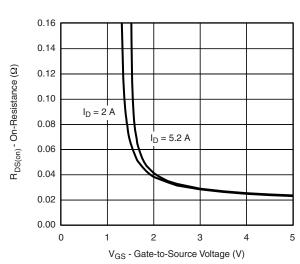










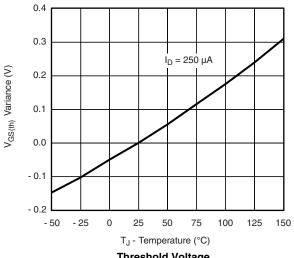


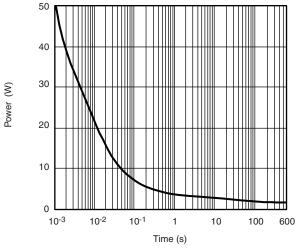
On-Resistance vs. Gate-to-Source Voltage

S - Source Current (A)

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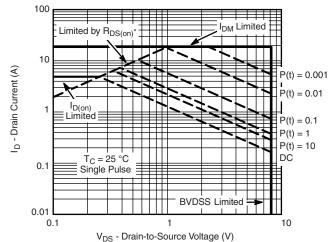
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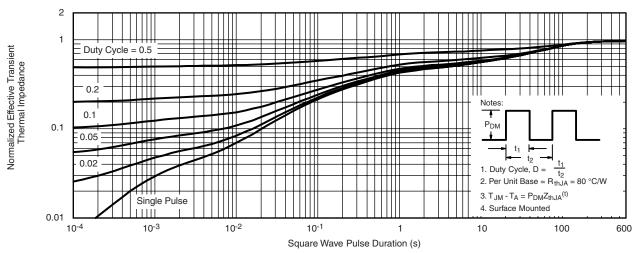
**Threshold Voltage** 

Single Pulse Power



\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

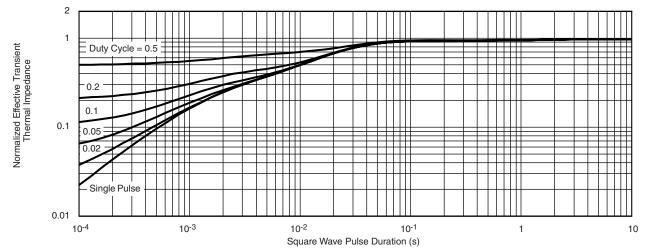
### Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg273251">www.vishay.com/ppg273251</a>.

Document Number: 73251 S-83054-Rev. B, 29-Dec-08



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